





#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on) max</sub>	<b>I</b> <sub>D</sub> Τ <sub>A</sub> = +25°C
	$0.4\Omega$ @ $V_{GS} = 4.5V$	1.5A
20V	0.5 Ω @ V <sub>GS</sub> = 2.5V	1.3A
	0.7 Ω @ V <sub>GS</sub> = 1.8V	1.1A

### **Features and Benefits**

- Low On-Resistance
- Very Low Gate Threshold Voltage V<sub>GS(TH)</sub>, 1.0V Max.
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surfaced Mount Package
- Ultra-Low Package Profile, 0.4mm Maximum Package Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(on)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions

### **Mechanical Data**

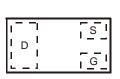
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)



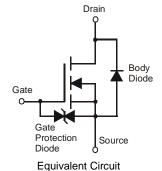




Bottom View



Top View Internal Schematic



### **Ordering Information** (Note 4)

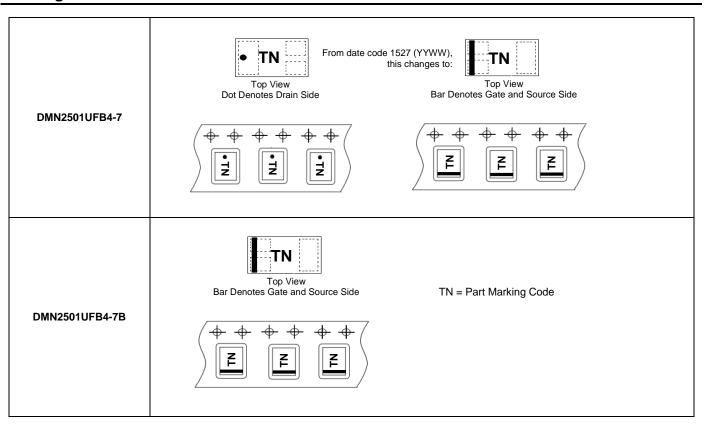
Ī	Part Number	Case	Packaging
	DMN2501UFB4-7	X2-DFN1006-3	3,000/Tape & Reel
	DMN2501UFB4-7B	X2-DFN1006-3	10.000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.



## **Marking Information**



## 

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
Continuous Dusin Coursest (Nata 5) V	Steady State	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	1.0 0.8	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = 4.5V	t<10s	$T_A = 25$ °C $T_A = 70$ °C	I <sub>D</sub>	1.2 0.9	А
Continuous Durin Courset (Note C) V	Steady State	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	1.5 1.2	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	t<10s	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	1.8 1.4	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I <sub>DM</sub>	6	А		
Maximum Body Diode continuous Current			Is	1	Α

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Units
$T_A = +25^{\circ}C$	٥	0.5	W
$T_A = +70^{\circ}C$	PD	0.3	VV
Steady State	5	251	°C/W
t<10s	$R_{\theta}$ JA	188	
$T_A = +25^{\circ}C$	0	1.2	W
$T_A = +70^{\circ}C$	PD	0.7	
Steady State	5	110	°C/W
t<10s	$R_{\theta}$ JA	82	
	$T_{J_i}T_{STG}$	-55 to +150	°C
	$T_A = +70$ °C Steady State t<10s $T_A = +25$ °C $T_A = +70$ °C Steady State	$\begin{array}{c c} T_A = +70^{\circ}\text{C} & P_D \\ \hline \text{Steady State} & R_{\theta}\text{JA} \\ \hline t < 10\text{s} & R_{\theta}\text{JA} \\ \hline T_A = +25^{\circ}\text{C} & P_D \\ \hline T_A = +70^{\circ}\text{C} & \\ \hline \text{Steady State} & \\ \hline t < 10\text{s} & R_{\theta}\text{JA} \\ \hline \end{array}$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.



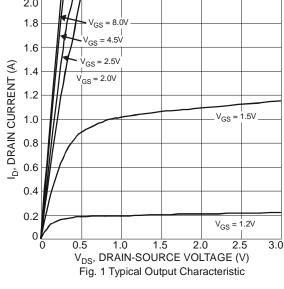
## **Electrical Characteristics** (@ $T_A = \pm 25$ °C, unless otherwise specified.)

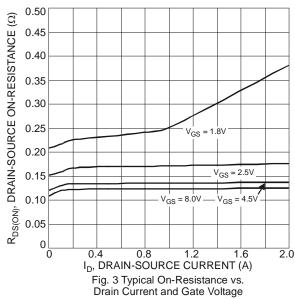
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	-	-	100	nA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±1	μΑ	$V_{GS} = \pm 6V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						•	
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.5	0.76	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
			170	400		$V_{GS} = 4.5V, I_D = 600mA$	
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	-	200	500	$m\Omega$	$V_{GS} = 2.5V, I_D = 500mA$	
			260	700		$V_{GS} = 1.8V, I_D = 350mA$	
Forward Transfer Admittance	Y <sub>fs</sub>	-	1.4	-	S	$V_{DS} = 10V, I_D = 400mA$	
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 150mA	
DYNAMIC CHARACTERISTICS (Note 8)		•	•		•	•	
Input Capacitance	C <sub>iss</sub>	-	82	-	pF	101/11/	
Output Capacitance	Coss	-	12	-	pF	$V_{DS} = 16V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	10	-	pF		
Gate resistance	Rg	-	83	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	-	1.1	-	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qq	-	2.0	-	nC	$V_{DS} = 10V, I_D = 250mA$	
Gate-Source Charge	Q <sub>qs</sub>	-	0.14	-	nC		
Gate-Drain Charge	Q <sub>ad</sub>	-	0.19	-	nC		
Turn-On Delay Time	t <sub>D(on)</sub>	-	6.6	-	ns		
Turn-On Rise Time	t <sub>r</sub>	-	6.4	-	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t <sub>D(off)</sub>	-	40.4	-	ns	$R_{L} = 47\Omega, R_{G} = 10\Omega,$ $I_{D} = 200\text{mA}$	
Turn-Off Fall Time	t <sub>f</sub>	-	17.3	-	ns		

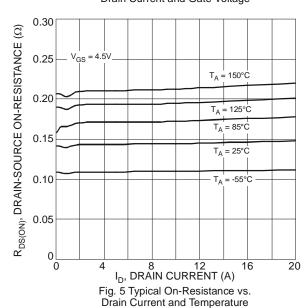
Notes:

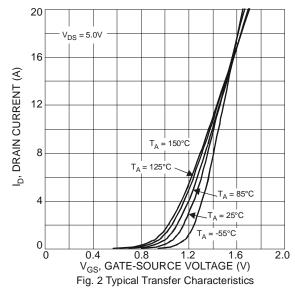
<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

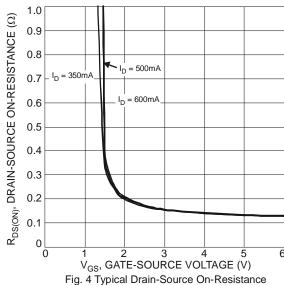












1.8

1.8

ON STANCE (NORMALIZED)

ON STANCE (NORMALIZE

vs. Gate-Source Voltage

Fig. 6 On-Resistance Variation with Temperature



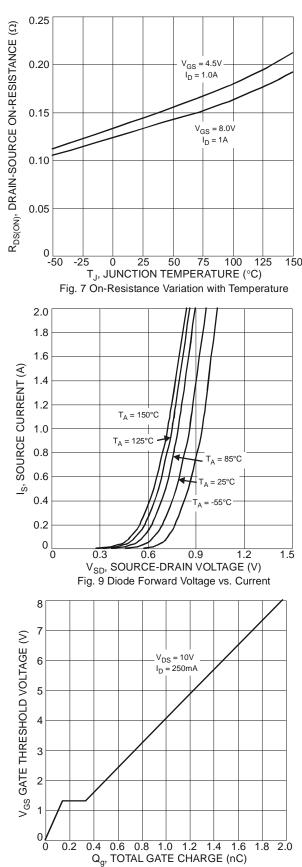


Fig. 11 Gate Charge

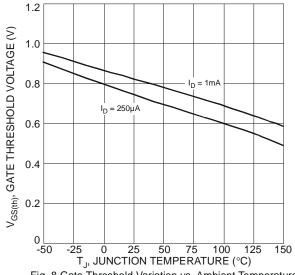
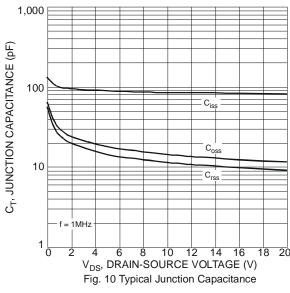
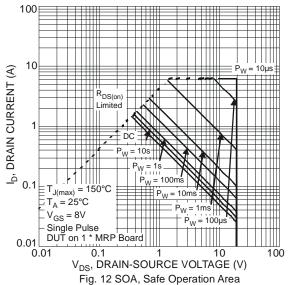
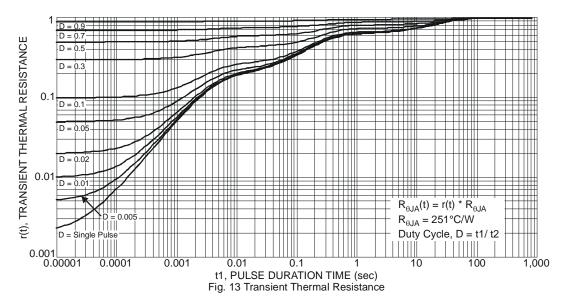


Fig. 8 Gate Threshold Variation vs. Ambient Temperature



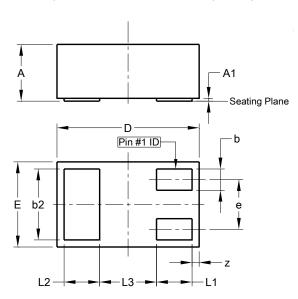






## **Package Outline Dimensions**

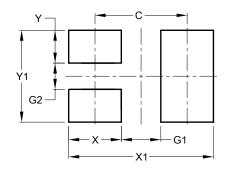
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



X2-DFN1006-3					
Dim	Min	Max	Тур		
Α		0.40	_		
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
e	1	1	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	1	1	0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.70			
G1	0.30			
G2	0.20			
Х	0.40			
X1	1.10			
Y	0.25			
Y1	0.70			



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